

## DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My address, residence, and citizenship are as stated below next to my name.

I believe I am an original, first, and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled Improved Copper Bath for Electroplating Fine Circuitry on Semiconductor Chips, the specification of which is attached hereto.

I have reviewed and understand the contents of the above-identified specification, including the claims.

I acknowledge my duty to disclose all information known to me to be material to patentability as defined in 37 CFR 1.56.

I claim the benefit under 35 USC 120 of any U.S. applications listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior U.S. application in the manner provided by the first paragraph of 35 USC 112, I acknowledge the duty to disclose material information, as defined in 37 CFR 1.56, which occurred between the filing date of the prior application and the national or PCT international filing date of this application:  
None.

I hereby appoint the following attorney to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith: John J. Deinken, Registration No. 28,406 and D. Morgan Tench, Registration No. 48,605.

Address all communications to John J. Deinken at:

Telephone calls: 805.373.4556  
FAX correspondence: 805.373.4672  
Mail correspondence: Rockwell Scientific Company  
P.O. Box 1085, MCA15  
Thousand Oaks, CA 91358-0085  
Electronic Mail correspondence: jdeinken@rwsc.com

All statements made herein of my own knowledge are true and all statements made on information and belief are believed to be true. These statements are made with the knowledge that willful false statements and the like are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and may jeopardize the validity of this application or any patent issued thereon.

Inventor: D. Morgan Tench  
Residence: 1180 Corte Riviera  
PO Address: Camarillo, CA 93010

Signature: D. Morgan Tench

Date: 9/26/03 Citizenship: U.S.A.

Inventor: John T. White  
Residence: 42254 Valley Vista Drive  
PO Address: Lancaster, CA 93536

Signature: John T. White

Date: 9/26/03 Citizenship: U.S.A.